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RoHS Reach Halogen Free Pb Free

交货型号	C1608JB0J685MT****	
用途	1 一般等级	B G
特点	General 一般(~75V)	
系列	C1608 [EIA 0603]	
状态	▲ 量产体制(新设计非推荐)	

	रन
长度(L)	1.60mm ±0.10mm
宽度(W)	0.80mm ±0.10mm
厚度(T)	0.80mm ±0.10mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	0.30mm Min.
推荐焊盘布局 (PA)	0.70mm to 1.00mm(Flow Soldering)
1世行/平益/即/可 (FA)	0.60mm to 0.80mm(Reflow Soldering)
推荐焊盘布局(PB)	0.80mm to 1.00mm(Flow Soldering)
1世存/产益4µ/ŋ (FD)	0.60mm to 0.80mm(Reflow Soldering)
推荐焊盘布局(PC)	0.60mm to 0.80mm(Flow Soldering)
1世行行並作内はし	0.60mm to 0.80mm(Reflow Soldering)

电气特性		
电容	6.8 µ F ±20%	
额定电压	6. 3VDC	
温度特性	JB(±10%)	
耗散因数 (Max.)	10%	
	14ΜΩ	

	其他
焊接方法	流体
库按方法	回流
AEC-Q200	NO
包装形式	纸编带(180mm卷筒)
包装个数	4000pcs

 $!\ \mbox{Images}$  are for reference only and show exemplary products.

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特性图表(这是参考数据,并不保证产品的特性。)

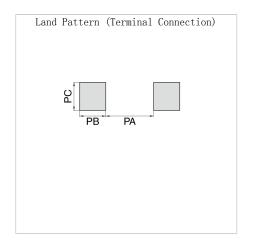
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## Associated Images



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